

Product Summary

Device	BVDSS	Rds(on) Max	I _D Max T _A = +25°C
Q1	201/	$0.4\Omega @ V_{GS} = 4.5V$	1.2A
QT	20V	0.5Ω @ V _{GS} = 2.5V	1.0A
00	2017	0.7Ω @ V _{GS} = -4.5V	-0.9A
Q2	-20V	0.9Ω @ V _{GS} = -2.5V	-0.8A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

Portable Electronics

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

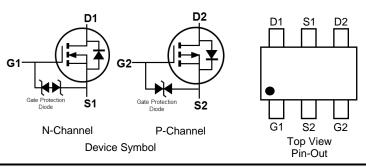
- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 🕄
- Weight: 0.015 grams (Approximate)





TSOT26

Top View



Ordering Information (Note 4)

Part Number	Case	Packaging
DMC2710UVT-7	TSOT26	3,000 / Tape & Reel
DMC2710UVT-13	TSOT26	10,000 / Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

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•	HX6	λM
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HX6 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Notes:

•												
Year	2018		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	F		I	J	K	L	М	Ν	0	Р	R	S
				-		-			-			_
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Character	ristic		Symbol	Q1 Value	Q2 Value	Unit
Drain-Source Voltage			V _{DSS}	20	-20	V
Gate-Source Voltage			Vgss	±6	±6	V
Continuous Drain Current (Note 6) N-Channel: V _{GS} = 4.5V P-Channel: V _{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	lD	1.2 0.9	-0.9 -0.7	A
Maximum Continuous Body Diode Forward Current (Note 6)			ls	0.9	-0.9	А
Pulsed Drain Current (10µs Pulse, Duty Cyc	le = 1%)		IDM	5	-2.5	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	0.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	204	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	0.8	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{OJA}	152	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics N-CHANNEL – Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						-
Drain-Source Breakdown Voltage	BVDSS	20	—	_	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	IDSS	—	—	100	nA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±1.0	μA	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	VGS(TH)	0.5	0.7	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
		_	0.18	0.4		V _{GS} = 4.5V, I _D = 600mA
Static Drain-Source On-Resistance	RDS(ON)	—	0.21	0.5	Ω	V _{GS} = 2.5V, I _D = 500mA
		_	0.27	0.7		V _{GS} = 1.8V, I _D = 350mA
Diode Forward Voltage	Vsd	—	0.7	1.2	V	$V_{GS} = 0V$, $I_{S} = 150mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	42	—	pF	
Output Capacitance	Coss	—	13	—	pF	VDS = 16V, VGS = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	6.5	_	pF	
Total Gate Charge	Qg		0.6	_		
Gate-Source Charge	Q _{gs}		0.1	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Drain Charge	Qgd		0.1	_		I _D = 250mA
Turn-On Delay Time	tD(ON)	_	4.9	_		
Turn-On Rise Time	t _R	_	3.1	—		$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	tD(OFF)		386	—	ns	$R_L = 47\Omega, R_G = 10\Omega$
Turn-Off Fall Time	tF	_	174	—	1	I _D = 200mA
Reverse Recovery Time	trr	_	88	—	ns	
Reverse Recovery Charge	Qrr	_	29	—	nC	I _F = 1A, di/dt = 100A/μs

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing. Notes:



Electrical Characteristics P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

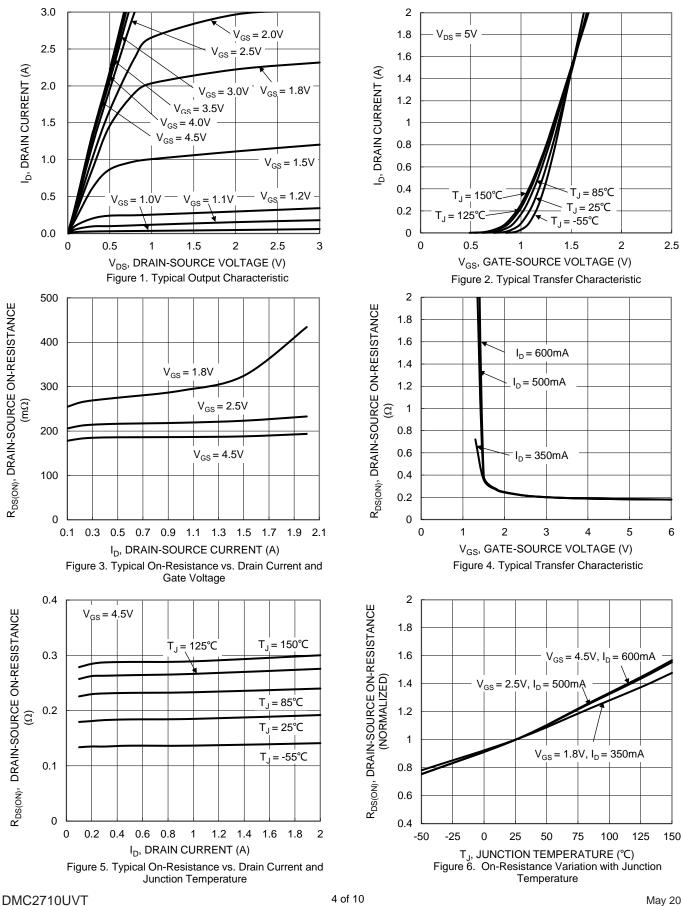
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	Symbol	IVIIII	тур	IVIAX	Unit	Test condition	
Drain-Source Breakdown Voltage	BVDSS	-20	_	_	V	Vgs = 0V, Ip = -250µA	
Zero Gate Voltage Drain Current	IDSS		_	-100	nA	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±1.0	μΑ	$V_{\rm DS} = \pm 4.5 V, V_{\rm DS} = 0 V$	
ON CHARACTERISTICS (Note 7)	1033		1	1.0	μ.,	VG3 = ±4.0V, VD3 = 0V	
Gate Threshold Voltage	Vgs(th)	-0.5	-0.8	-1.0	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	
		_	0.47	0.7		V _{GS} = -4.5V, I _D = -430mA	
Static Drain-Source On-Resistance	RDS(ON)	_	0.58	0.9	Ω	Vgs = -2.5V, Ip = -300mA	
		—	0.76	1.3		$V_{GS} = -1.8V, I_D = -150mA$	
Diode Forward Voltage	Vsd	_	-0.7	-1.2	V	V _{GS} = 0V, I _S = -150mA	
DYNAMIC CHARACTERISTICS (Note 8)						-	
Input Capacitance	Ciss	_	49	_	pF		
Output Capacitance	Coss	_	12	_	pF	$V_{DS} = -16V, V_{GS} = 0V$ - f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	3.4	_	pF	1 = 1.000112	
Total Gate Charge	Qg		0.7	_			
Gate-Source Charge	Qgs		0.1	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$	
Gate-Drain Charge	Qgd	_	0.1	—		$I_D = -250 \text{mA}$	
Turn-On Delay Time	tD(ON)	_	16	_			
Turn-On Rise Time	t _R	_	15	—	1	$V_{DD} = -10V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	tD(OFF)	_	213	—	ns	$R_L = 47\Omega, R_G = 10\Omega$ $I_D = -200 \text{mA}$	
Turn-Off Fall Time	tF		89	_		ID = -200IIIA	
Reverse Recovery Time	t _{RR}		10.5	—	ns		
Reverse Recovery Charge	Qrr	_	1.8	—	nC	IF = -1A, di/dt = 100A/µs	

Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.

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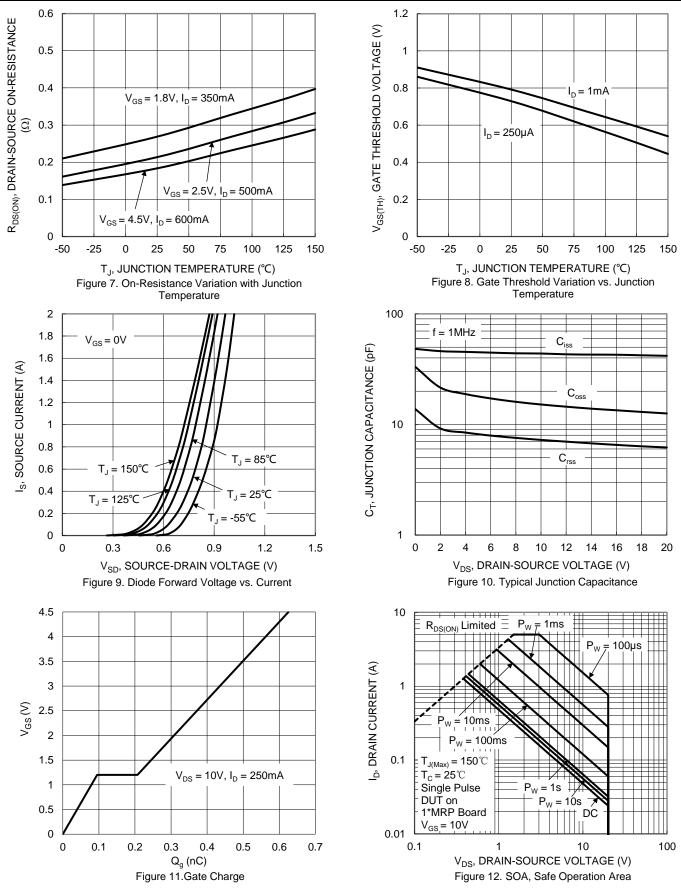
Typical Characteristics - N-CHANNEL



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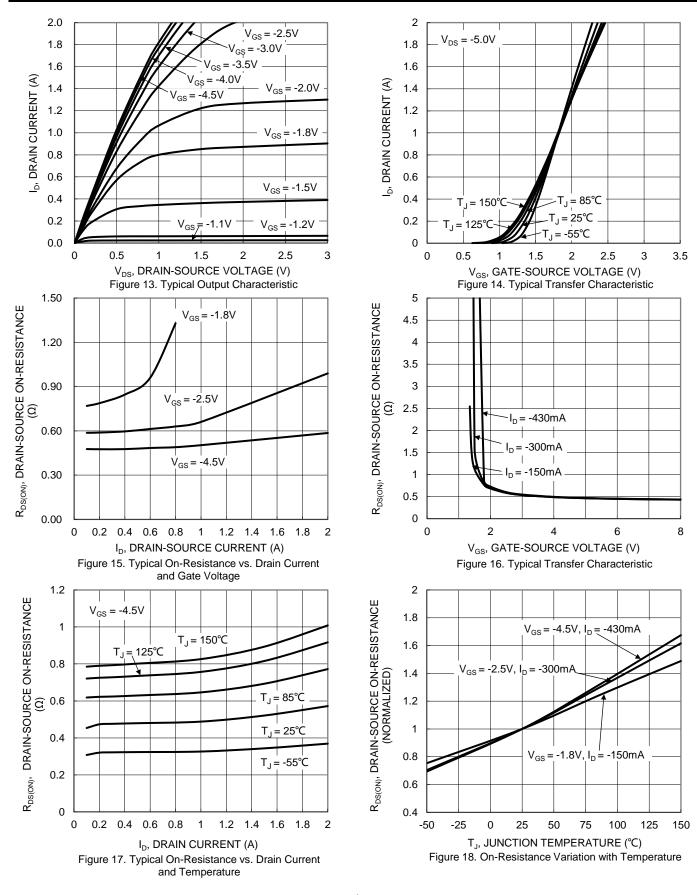
Typical Characteristics - N-CHANNEL (continued)



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Typical Characteristics - P-CHANNEL

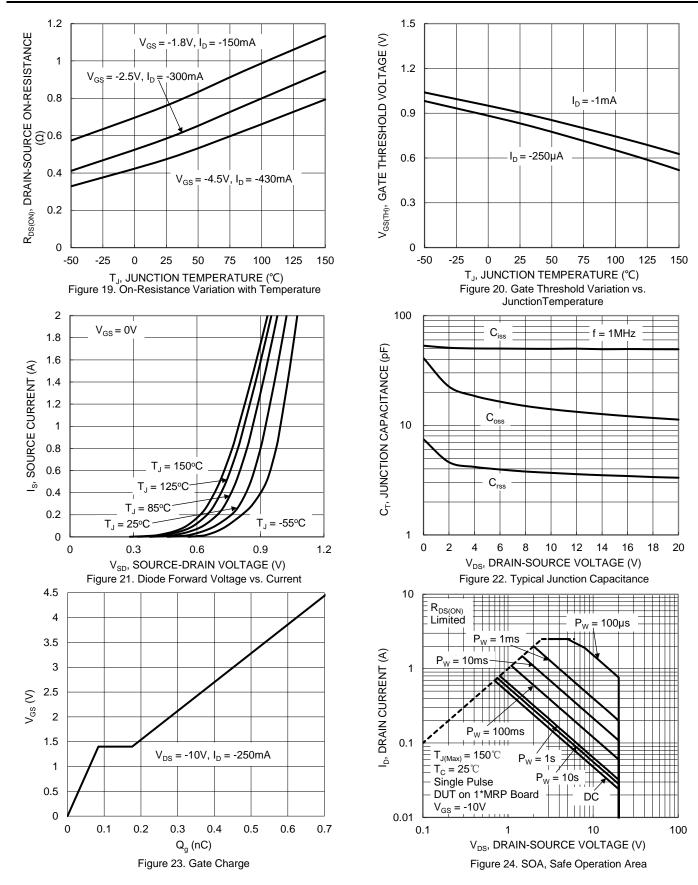


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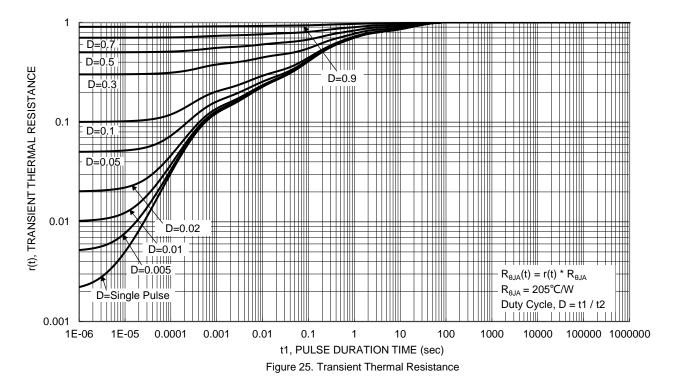


Typical Characteristics - P-CHANNEL (continued)



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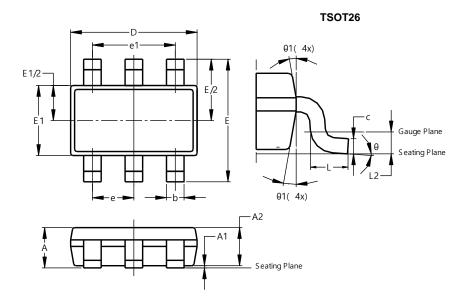






Package Outline Dimensions

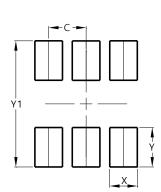
Please see http://www.diodes.com/package-outlines.html for the latest version.



	TS	OT26					
Dim	Min	Max	Тур				
Α	-	1.00	-				
A1	0.010	0.100	-				
A2	0.840	0.900	-				
D	2.800	3.000	2.900				
ш	2	2.800 BSC					
E1	1.500	1.700	1.600				
b	0.300	0.450	-				
Ċ	0.120	0.200	-				
e	0	.950 BS	С				
e1	1	.900 BS	С				
L	0.30	0.50	-				
L2	0	.250 BS	С				
θ	0°	8°	4°				
θ1	4°	12°	-				
A	II Dimen	sions in	mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26

Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.200



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